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Substitute for form 1449A/PTO		Complete if Known			
		Application Number	09/945535		
04		Filing Date	August 30, 2001		
0.11		First Named Inventor	Ahn, Kie		
	\chi_2\	Group Art Unit	2813		
FEB 1 1 2003	1 200% is	Examiner Name	Blum, David		
Sheet 1 of 1		Attorney Docket No: 1	303.026US1		

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	US-6,093,944	07/25/2003	VanDover, R B.	257	310	06/04/1998
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Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	T²

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Examiner Initials*	- Cite No 1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T
As		CHAMBERS, J J., et al., "Physical and electrical characterization of ultrathin yttrium silicate insulators on silicon", <u>Journal of Applied Physics</u> , 90(2), (July 15, 2001), 918-33	
		KUKLI, KAUPO, et al., "Low-Temperature Deposition of Zirconium Oxide-Based Nanocrystalline Films by Alternate Supply of Zr[OC(CH3)3]4 and H2O", Chemical Vapor Deposition, 6(6), (2000), 297-302	
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EXAMINER	1/2	15	DATE CONSIDERED	Yhrloy
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(Use as many sheets as necessary)	Filing Date	August 30, 2001			
	First Named Inventor	Ahn, Kie			
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FEB 1 1 200% No.	Examiner Name	Blum, David			
Sheet 1 of 1	Attorney Docket No: 1	1303.026US1			

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As		CHAMBERS, J J., et al., "Physical and electrical characterization of ultrathin yttrium silicate insulators on silicon", <u>Journal of Applied Physics</u> , 90(2), (July 15, 2001), 918-33	
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